









PRODUCT DATASHEET



- ► PLCC4 SMD
- ➤ 3528 1.9t Series
- ➤ Yellow (590nm)

N0Y60S54-50MA





3528 1.9t Series





AEC-Q101

FEATURES:

Package: PLCC4 Top View White SMT Package

Forward Current: 70mA Forward Voltage (typ.): 2.2V

Luminous Intensity (typ.): 2560mcd@70mA

Colour: Yellow

Wavelength: 585~594nm Viewing angle: 120°

Materials:

Resin: Silicon (Water Clear)

L/T Finish: Ag plated

Operating Temperature: -40~+105°C

Storage Temperature: -40~+105°C

ESD (HBM): 2kV

Grouping parameters:

Forward voltage

Luminous intensity

Dominant Wavelength

Soldering methods: IR Reflow MSL: acc. to JEDEC Level 2a (J-STD20D)

Packing: 8mm tape with max.2000/reel, ø180mm (7")

APPLICATIONS:

- Automotive
- **Decorative Lighting**
- Indicator
- Backlighting
- Dashboard
- Display
- Information Board
- Light Strip



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	70	mA
Pulse Forward Current Duty 1/10, width 0.1mS	IPF	150	mA
Reverse Voltage	V _R	10	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	125	°C
Thermal Resistance Junction to Solder Point	R _{thJ} -s	100	°C/W
Electrostatics Discharge (HBM)	ESD	2000	V
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	T _{SD}	260	°C

Electrical & Optical Characteristics (Ta=25°C)

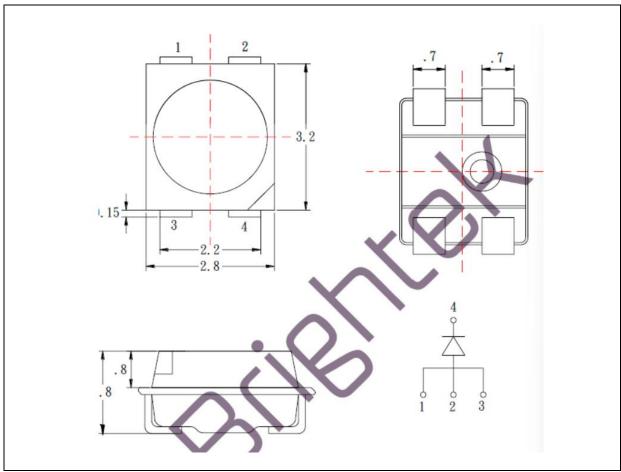
Parameter Symbol		Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V_{F}	1.8	2.2	2.8	V	I _F =50mA
Luminous Intensity	lv	1300	2560		mcd	I _F =50mA
Dominant Wavelength	λ_{D}	585		597	nm	I _F =50mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =50mA

 $^{1. \}quad \text{Luminous intensity (I$_{V}$) $\pm 10\%$, Forward Voltage (V$_{F}$) ± 0.1V, Viewing angle ($2\theta_{1/2}$) $\pm 5\%$, Wavelength ± 1nm}$



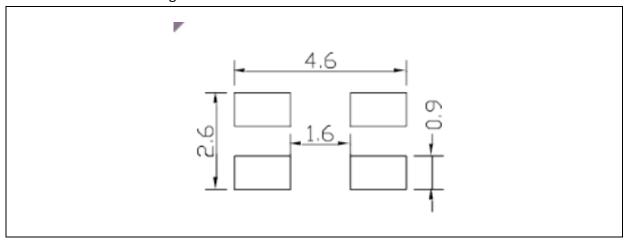
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 50mA):

Code	Min.	Max.	Unit
В	1.8	1.9	
С	1.9	2.0	
D	2.0	2.1	
E	2.1	2.2	
F	2.2	2.3	V
G	2.3	2.4	V
Н	2.4	2.5	
I	2.5	2.6	
J	2.6	2.7	
К	2.7	2.8	

Luminous Intensity Classifications (I_F = 50mA):

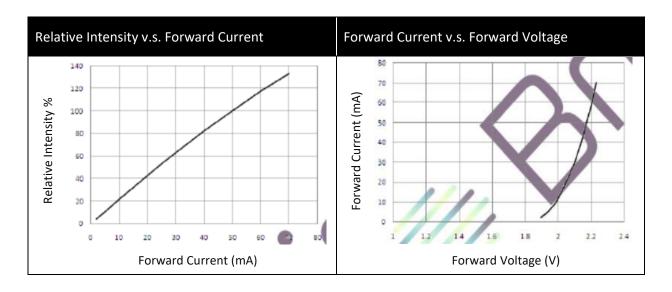
Code	Min.	Max.	Unit
16	1300	1700	
17	1700	2200	mad
18	2200	2800	mcd
19	2800	3600	

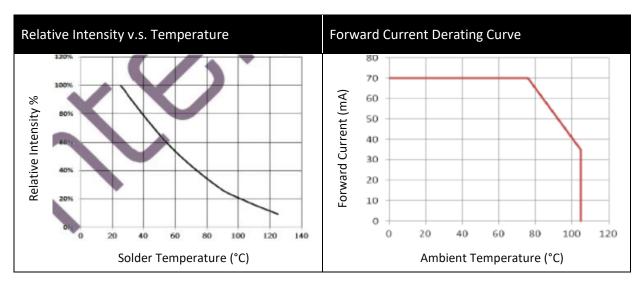
Dominant Wavelength Classifications (IF = 50mA):

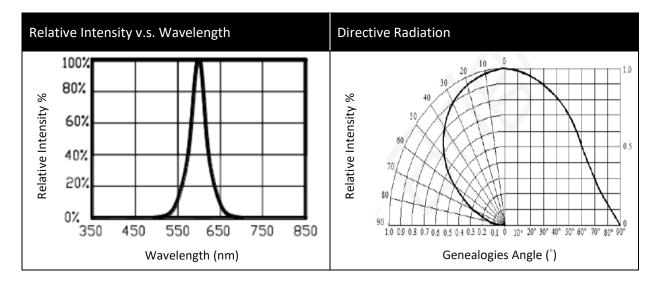
Code	Min.	Max.	Unit
С	585	588	
D	588	591	
E	591	594	nm
F	594	597	



ELECTRO-OPTICAL CHARACTERISTICS:

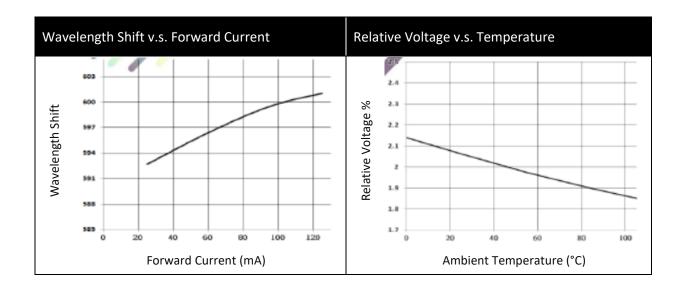






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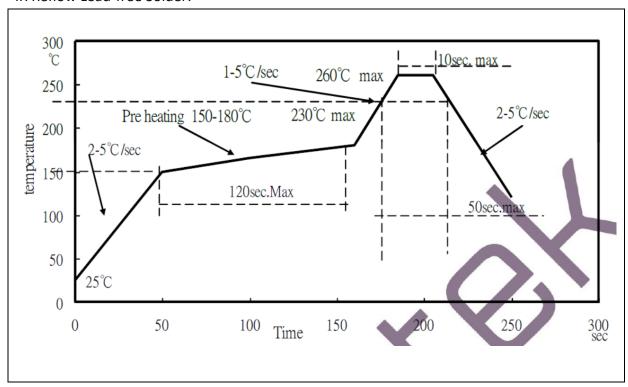






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



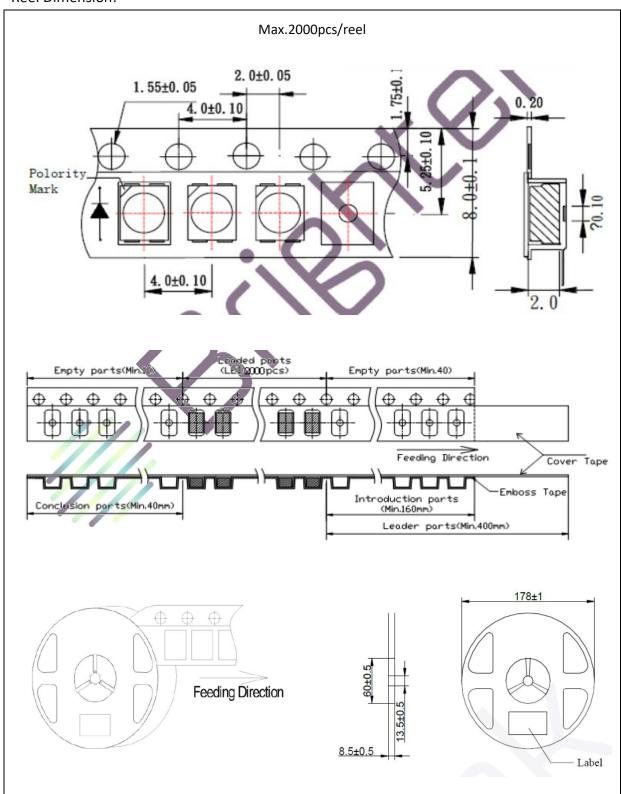
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

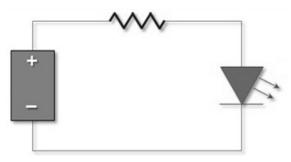
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, for reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	19/03/2019	Datasheet set-up.
A1.1	04/06/2022	New datasheet format.